

## USB Downstream Port Terminator

### Features

- A low-capacitance USB downstream port terminator, EMI filter, and transient over-voltage (ESD) protector in a single surface-mounted package
- ESD protection to  $\pm 20\text{kV}$  contact discharge, per MIL-STD-883D, Method 3015
- ESD protection to  $\pm 15\text{kV}$  contact discharge, per IEC 61000-4-2 International Standard
- Compact SOT23-5 and SC70-5 package options save board space and lower manufacturing costs compared to discrete solutions
- Capacitors matched to a precision exceeding the USB specification
- Pin-compatible with ST Microelectronics USBDFxxW5 USB Downstream Port Terminator
- Lead-free versions available

### Applications

- ESD protection and termination of USB downstream ports
- Desktop PCs
- Notebooks
- Set-top boxes
- USB hubs

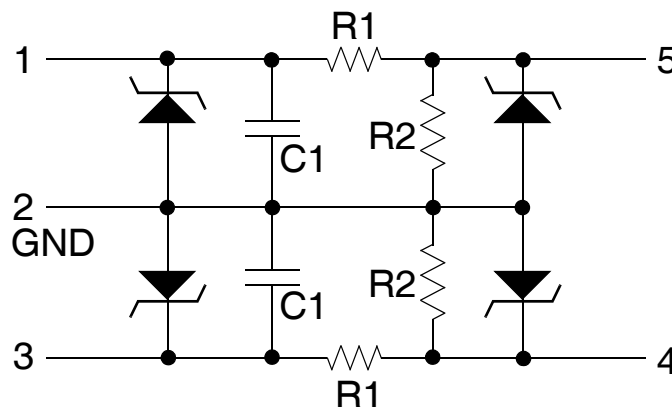
### Product Description

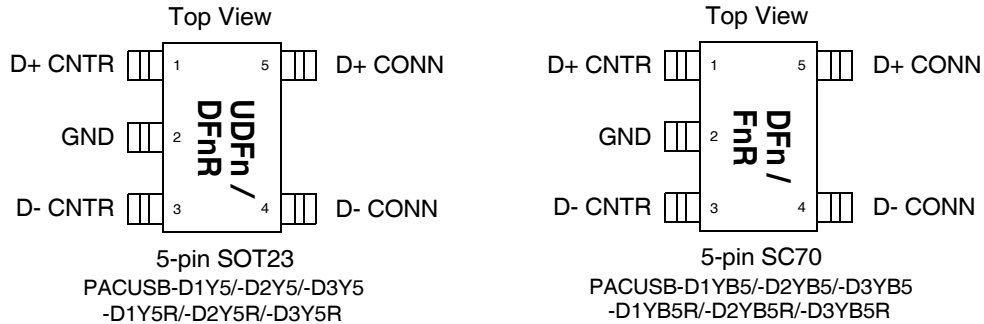
The PACUSB-D1/D2/D3 is a single-channel USB downstream-port termination network. It integrates EMI/RFI filter components R1 and C1, as recommended by the USB specification as well as the required  $15\text{k}\Omega$  pull-down resistors (R2) to GND. In addition, PACUSB-D1/D2/D3 provides a very high level of protection for sensitive electronic components that may be subjected to electrostatic discharge (ESD). The device pins will safely dissipate ESD strikes of  $\pm 15\text{kV}$ , exceeding the maximum requirements of the IEC 61000-4-2 international standard. Using the MIL-STD-883D (Method 3015) specification for Human Body Model (HBM) ESD, all pins are protected from contact discharges to  $\pm 20\text{kV}$ .

There are three options for the value of the series resistor R1:  $15\Omega$ ,  $22\Omega$ , and  $33\Omega$ . This series resistance, plus the USB driver output resistance, must be close to the USB cable's characteristic impedance of  $45\Omega$  (each side) to minimize transmission line reflections.

The PACUSB-D1/D2/D3 is manufactured in a 5-pin SC70 or a 5-pin SOT23 package and is available with optional lead-free finishing.

### Electrical Schematic



**PACKAGE / PINOUT DIAGRAMS**


Note 1: The "n" shown in part markings above represents either the digit "1," "2," or "3."

Note 2: SOT23 and SC70 package sizes may differ. These drawings are not to scale.

**PIN DESCRIPTIONS**

PINS	NAME	DESCRIPTION
1	D+ CNTR	D+ Data to the USB controller circuitry
2	GND	Ground Pin
3	D- CNTR	D- Data to the USB controller circuitry
4	D- CONN	D- Data to the USB connector
5	D+ CONN	D+ Data to the USB connector

**Ordering Information**
**PART NUMBERING INFORMATION**

Pins	R1 Value	Package	Standard Finish		Lead-free Finish	
			Ordering Part Number <sup>1</sup>	Part Marking	Ordering Part Number <sup>1</sup>	Part Marking
5	15 Ω	SOT23-5	PACUSB-D2Y5	UDF2	PACUSB-D2Y5R	DF2R
	22 Ω		PACUSB-D3Y5	UDF3	PACUSB-D3Y5R	DF3R
	33 Ω		PACUSB-D1Y5	UDF1	PACUSB-D1Y5R	DF1R
5	15 Ω	SC70-5	PACUSB-D2YB5	DF2	PACUSB-D2YB5R	F2R
	22 Ω		PACUSB-D3YB5	DF3	PACUSB-D3YB5R	F3R
	33 Ω		PACUSB-D1YB5	DF1	PACUSB-D1YB5R	F1R

Note 1: Parts are shipped in Tape & Reel form unless otherwise specified.

**Specifications**

<b>ABSOLUTE MAXIMUM RATINGS</b>		
<b>PARAMETER</b>	<b>RATING</b>	<b>UNITS</b>
Storage Temperature Range	-65 to +150	°C
Power Dissipation per Resistor	100	mW
Package Power Dissipation	200	mW
Voltage on any pin (DC)	6	V

<b>STANDARD OPERATING CONDITIONS</b>		
<b>PARAMETER</b>	<b>RATING</b>	<b>UNITS</b>
Operating Temperature	-40 to +85	°C

**Specifications (cont'd)**

ELECTRICAL OPERATING CHARACTERISTICS (SEE NOTE 1)						
SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
R1	Resistance of R1 Resistor (PACUSB-D2Y5/Y5R, -D2YB5/YB5R)	$T_A = 25^\circ\text{C}$	12	15	18	$\Omega$
R1	Resistance of R1 Resistor (PACUSB-D3Y5/Y5R, -D3YB5/YB5R)	$T_A = 25^\circ\text{C}$	17.6	22	26.4	$\Omega$
R1	Resistance of R1 Resistor (PACUSB-D1Y5/Y5R, -D1YB5/YB5R)	$T_A = 25^\circ\text{C}$	26.4	33	39.6	$\Omega$
R2	Resistance of R2 Resistor	$T_A = 25^\circ\text{C}$		15		$k\Omega$
TCR	Temperature Coefficient of Resistance	Note 1		$\pm 1300$		ppm/ $^\circ\text{C}$
C1	Capacitance of C1 Capacitor	0 VDC; 30 mVAC; 1MHz; $25^\circ\text{C}$	37.6	47	56.4	pF
		2.5 VDC; 30 mVAC; 1MHz; $25^\circ\text{C}$	25.6	32	38.4	pF
TOL <sub>CM</sub>	Matching Tolerance of C1 Capacitors	1MHz; $25^\circ\text{C}$			$\pm 2$	%
I <sub>LEAK</sub>	Diode Leakage Current to GND	Measured at 3.3 VDC, $25^\circ\text{C}$		1	100	nA
V <sub>RB</sub>	Diode Reverse Bias Voltage	I <sub>LOAD</sub> = 10 $\mu\text{A}$ ; $T_A = 25^\circ\text{C}$	5.5			V
V <sub>SIG</sub>	Signal Voltage: Positive Clamp Negative Clamp	I <sub>LOAD</sub> = 10mA; $T_A = 25^\circ\text{C}$	5.6	6.8	9.0	V
		I <sub>LOAD</sub> = 10mA; $T_A = 25^\circ\text{C}$	-0.4	-0.8	-1.5	V
V <sub>ESD</sub>	In-system ESD Withstand Voltage MIL-STD-883D, Method 3015 (HBM) IEC 61000-4-2 Contact Discharge	Pins 1, 3; Notes 2,3 and 4	$\pm 4$			kV
		Pins 4, 5; Notes 2 and 3	$\pm 20$			kV
		Pins 4, 5; Notes 2 and 3	$\pm 15$			kV
V <sub>CL</sub>	Clamping voltage under ESD discharge	MIL-STD-883D, Method 3015 +8kV; Notes 2 and 5		12		V
		MIL-STD-883D, Method 3015 - 8kV; Notes 2 and 5		-7		V

Note 1: Electrical operating characteristics guaranteed over standard operating conditions unless specified otherwise.

Note 2: Guaranteed by design and characterization.

Note 3: ESD voltage applied to pins with respect to GND, one at a time; unused pins are left open.

Note 4: Pins 1 and 3 are not connected to the USB port connector, and therefore are not exposed to external ESD hazards. Thus, they do not require the high ESD protection levels provided for pins 4 and 5.

Note 5: ESD Clamping Voltage is measured at the opposite end of R1 from the pin to which the ESD discharge is applied (e.g., if ESD is applied to pin 6, then the clamping voltage is measured at pin 1).

## Performance Information

### Capacitance vs. Voltage

The C1 capacitance value as a function of DC voltage across it is presented in Figure 1. The curve is normalized to a capacitance of 1.0 capacitance units at 2.5 VDC.

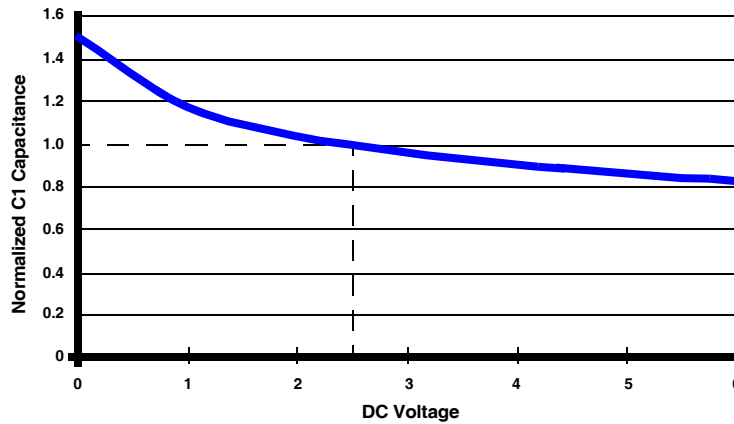


Figure 1. Diode Capacitance vs. DC Voltage (Normalized)

### Insertion Loss vs. Frequency Characteristics

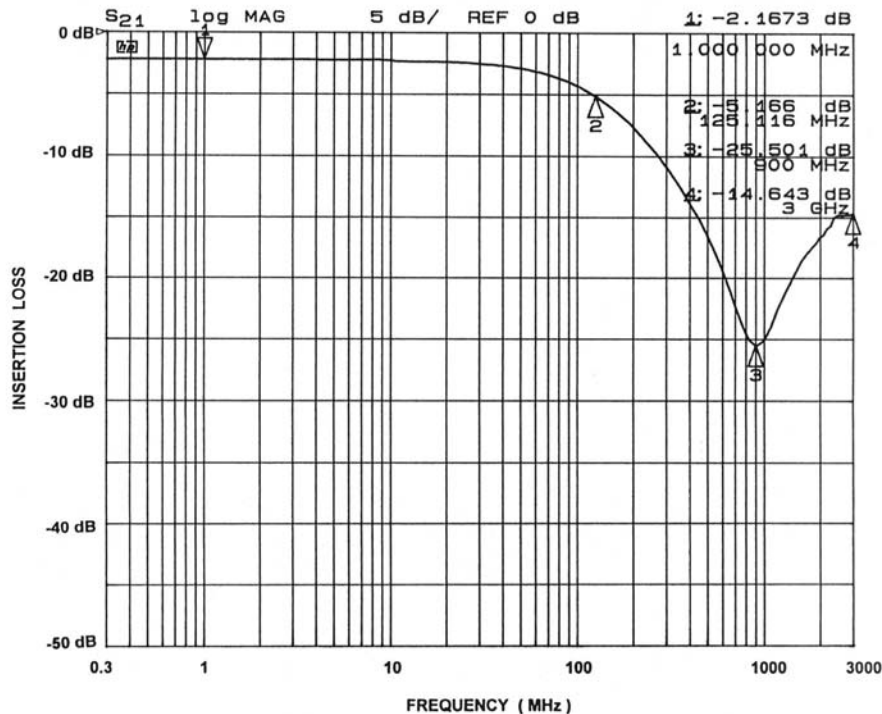
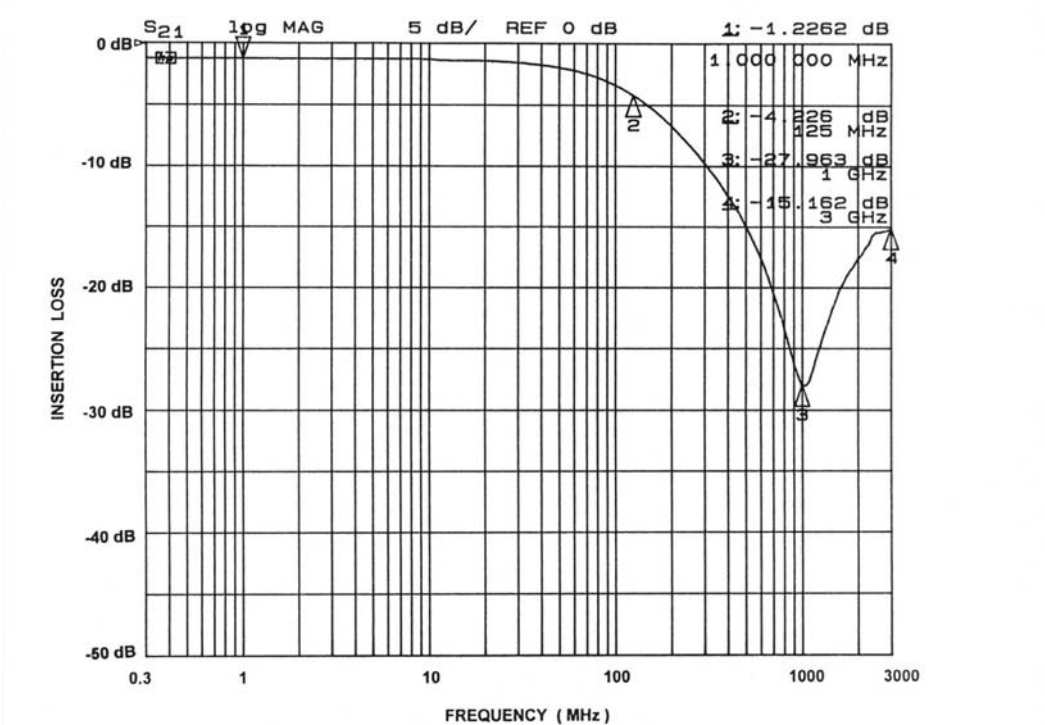
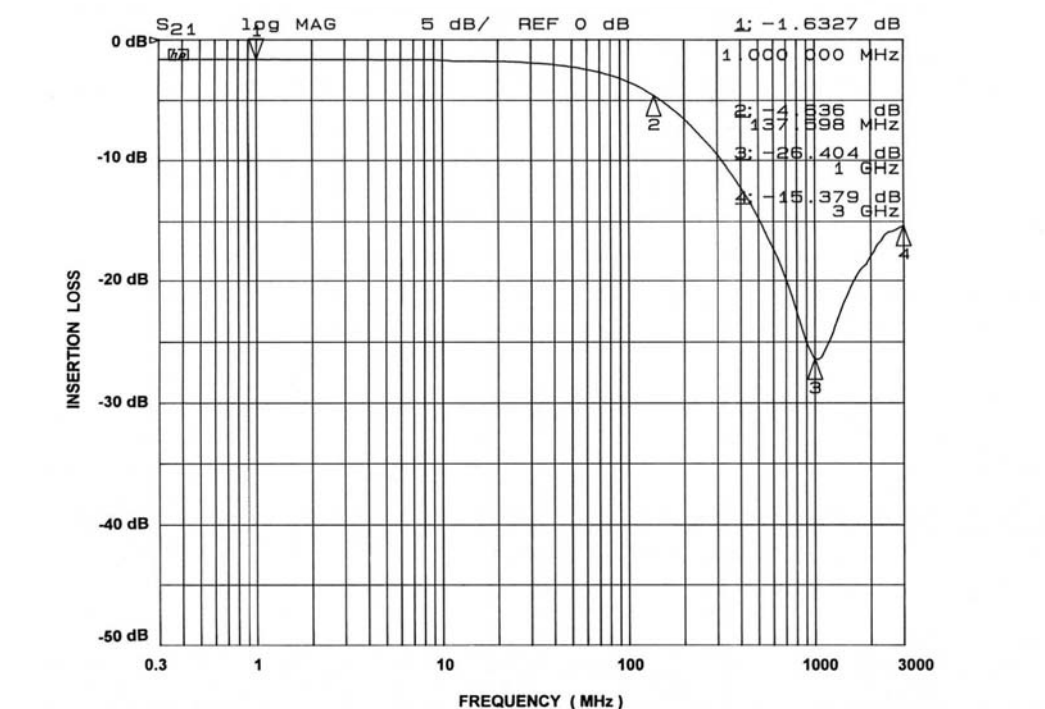


Figure 2. Insertion Loss vs. Frequency Performance Curve, PACUSB-D1(SOT23-6)

**Performance Information (cont'd)**



**Figure 3. Insertion Loss vs. Frequency Performance Curve, PACUSB-D2(SOT23-6)**



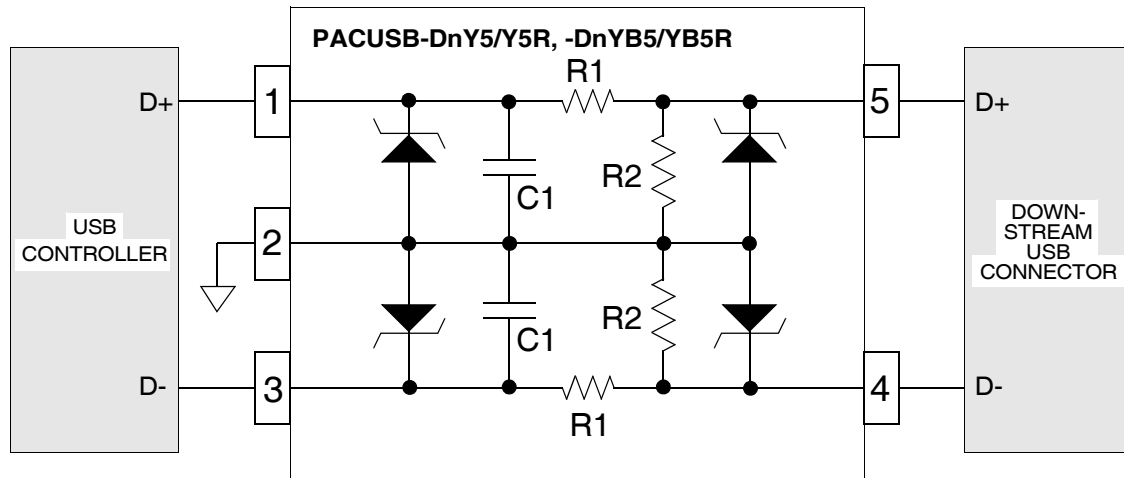
**Figure 4. Insertion Loss vs. Frequency Performance Curve, PACUSB-D3(SOT23-6)**

## Application Information

The PACUSB-D1/D2/D3 provides a complete interface for a single downstream USB port typically found in computers and USB hubs. It integrates the series resistors (R1) and the 15kΩ pull-down resistors (R2) for both USB data lines (D+ and D-) as well as the capacitors to ground for EMI suppression. Zener diodes provide ESD protection up to 15kV contact dis-

charge per the IEC 61000-4-2 standard and protect the USB controller on both data lines.

The PACUSB-D1/D2/D3 should be placed on the PCB between the USB controller and the USB connector, as shown on the Connection Diagram [Figure 5](#).



**Figure 5. Connection Diagram for PACUSB-D1/D2/D3 Devices**

To guarantee the best ESD and filtering performance, it is recommended to physically locate the PACUSB-D1/D2/D3 close to the USB connector. Also, the trace lengths between the PACUSB-D1/D2/D3 and the USB controller should be kept as short as possible.

### Mechanical Details

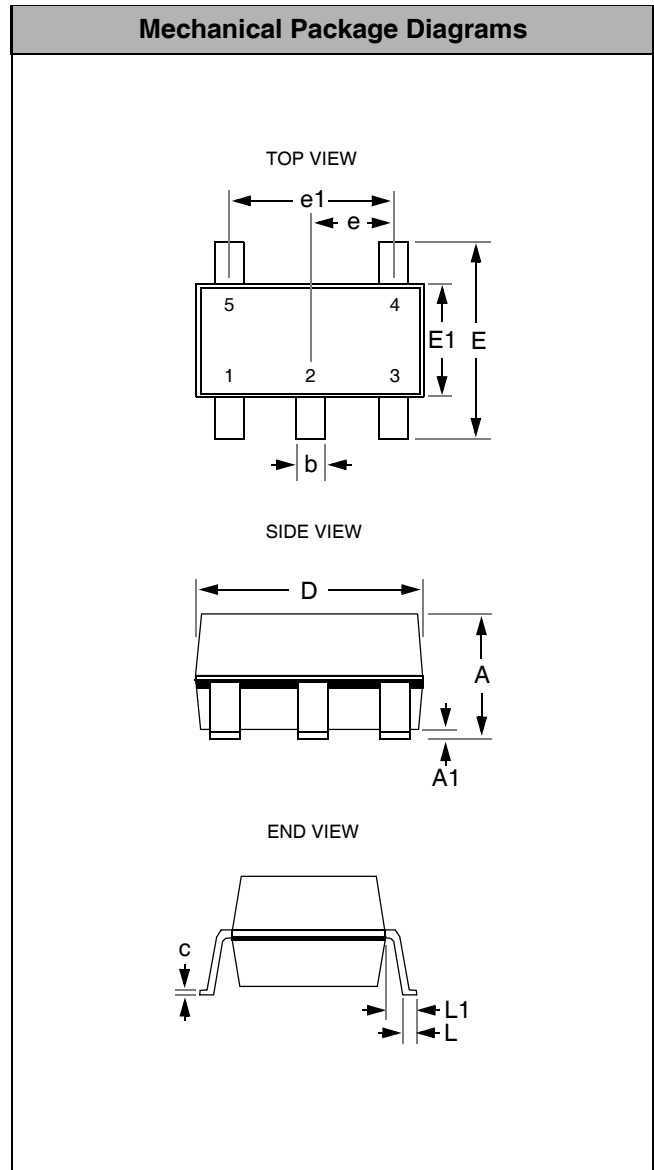
PACUSB-D1/D2/D3 devices are packaged in SOT23-5 and SC70-5 packages.

#### SOT23-5 Mechanical Specifications:

Dimensions for PACUSB-D1/D2/D3 devices packaged in a 5-pin SOT23 package are presented below.

For complete information on the SOT23-5 package, see the California Micro Devices SOT23 Package Information document.

PACKAGE DIMENSIONS				
Package	SOT23-5 (JEDEC name is MO-178)			
Pins	5			
Dimensions	Millimeters		Inches	
	Min	Max	Min	Max
A	--	1.45	--	0.057
A1	0.00	0.15	0.000	0.006
b	0.30	0.50	0.012	0.020
c	0.08	0.22	0.003	0.009
D	2.75	3.05	0.108	0.120
E	2.60	3.00	0.102	0.118
E1	1.45	1.75	0.057	0.069
e	0.95 BSC		0.0374 BSC	
e1	1.90 BSC		0.0748 BSC	
L	0.30	0.60	0.0236	0.024
L1	0.60 REF		0.024 REF	
# per tape and reel	3000 pieces*			
Controlling dimension: millimeters				



Package Dimensions for SOT23-5.

\* This is an approximate amount which may vary.



## Mechanical Details (continued)

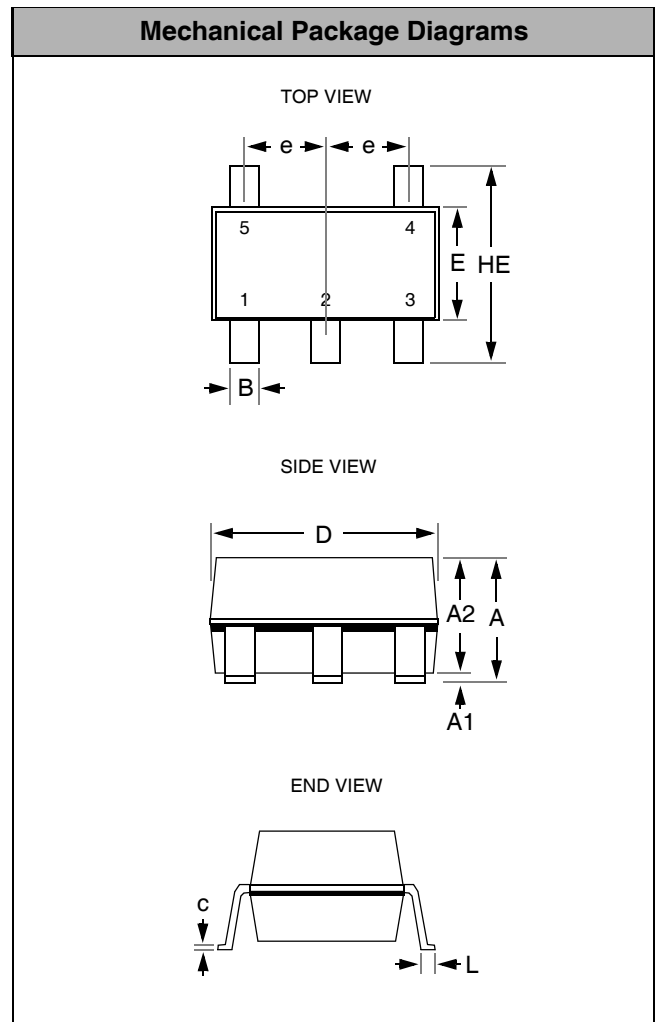
### SC70-5 Mechanical Specifications:

Dimensions for PACUSB-D1/D2/D3 devices packaged in a 5-pin SC70 package are presented below.

For complete information on the SC70-5 package, see the California Micro Devices SC70 Package Information document.

PACKAGE DIMENSIONS		
Package	SC70-5 (JEDEC name is MO-203 Issue A)	
Pins	5	
Dimensions	Millimeters	
	Min	Max
A	0.80	1.10
A1	0.00	0.10
A2	0.70	1.00
B	0.15	0.30
c	0.08	0.25
D	1.85	2.25
E	1.15	1.35
e	0.65 BSC	
HE	2.00	2.40
L	0.26	0.46
# / bag	1000 pieces*	
# / tape and reel	3000 pieces*	

\* This is an approximate amount which may vary.



**Package Dimensions for SC70-5.**